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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, POR, WDT
Number of I/O	13
Program Memory Size	1.75KB (1K x 14)
Program Memory Type	OTP
EEPROM Size	128 x 8
RAM Size	96 x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	18-SOIC (0.295", 7.50mm Width)
Supplier Device Package	18-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16ce624t-20e-so

MPLAB® ICE 2000

Processor Module and Device Adapter Specification

CONTENTS

1.0   INTRODUCTION

The processor modules for MPLAB ICE 2000 are interchangeable personality modules that allow MPLAB ICE 2000 to be reconfigured for emulation of different PICmicro® microcontrollers (MCUs). This modularity allows the emulation of many different devices with the addition of a processor module and device adapter, which provides a very cost effective multiprocessor emulation system.

The device adapters for MPLAB ICE 2000 are interchangeable assemblies that allow the emulator system to interface to a target application system. device adapters also have control logic that allows the target application to provide a clock source and power to the processor module. The device adapters support PICmicro MCUs in DIP, SDIP and PLCC packages.

Transition Sockets, used along with a device adapter, provide a method of accommodating all PICmicro MCU packages, including SOIC, SSOP, PQFP and TQFP packages.

2.0   MPLAB ICE 2000 SYSTEM

A brief overview of the different components of the system is shown in the figure below. Each component is discussed in the following subsections.

FIGURE 2-1:   MPLAB ICE 2000 EMULATOR SYSTEM

2.1   Host to Pod Cable

This is a standard parallel interface cable. MPLAB ICE 2000 is tested with a 6-foot cable. A longer cable may work, but is not guaranteed. The cable connects to a parallel port on the PC. If a PC has a printer connected to an LPT device, it is recommended that an additional interface card be installed, rather than using a splitter or an A/B switch.

2.2   Emulator Pod

The Emulator Pod contains emulator memory and control logic. MPLAB ICE 2000 contains a main board and an additional board for expanded trace memory and complex control logic. There are no field service-able parts in the pod. For more information on the pod, see the MPLAB ICE 2000 on-line help file in MPLAB IDE (*Help>Topics*) or the *MPLAB ICE 2000 User's Guide* (DS51488).

The MPLAB ICE 2000 processor module is inserted into the pod for operation.

2.3   Processor Module

The processor module contains the emulator chip, logic and low-voltage circuitry. There are no field serviceable parts mounted on the printed circuit board housed within the processor module enclosure.

2.4   Flex Circuit Cable

Once the processor module is inserted into the emulator pod, the flex circuit cable extends the emulator system to the target application. This is a custom cable that is attached inside the processor module enclosure and can be replaced in the field by removing the end cap of the processor module enclosure.

Please, DO NOT PULL on the flex circuit cable to remove the processor module from the pod. Use the fins of the processor module end cap to leverage the module from the pod.

Emulator analog functions may not operate within the performance specifications published in the device data sheet due to parasitic capacitance (up to 120 pf) of the flex cable.

2.5   Device Adapter

The device adapter provides a common interface for the device being emulated. It is provided in standard DIP and PLCC styles. The adapter also contains a special device that provides an oscillator clock to accurately emulate the oscillator characteristics of the PICmicro MCU.

Due to components on the device adapter, which require target power, the device adapter should be removed from the flex circuit cable (see Figure 2-1) when emulator power is being used and the processor module is not connected to the target. This will eliminate any loading effects on I/O pins.

2.6   Transition Socket

Transition Sockets are available in various styles to allow a common device adapter to be connected to one of the supported surface mount package styles. Transition sockets are available for various pin counts and pitches for SOIC, QFP and other styles. For more information on transition sockets, see the *MPLAB ICE 2000/4000 Transition Socket Specification* (DS51194).

An emulator system consists of the following components which can be ordered separately:

• An emulator pod (including the host-to-pod cable and power supply)
• A processor module (including the flex circuit cable)
• A device adapter
• An optional transition socket (for surface mount emulation)

3.0   EMULATOR-RELATED ISSUES

General limitations that apply to the MPLAB ICE 2000 emulator may be found in the on-line help. Select *Help>Topics* and then select "MPLAB ICE 2000" under "Debuggers".

Device-specific limitations can be found as above or by selecting *Debugger>Settings*, clicking the **Limitations** tab, and then clicking the **Details** button.

4.0   PROCESSOR MODULES

Processor modules are identified on the top of the assembly (e.g., PCM18XA0). To determine which processors are supported by a specific module, refer to the file "Readme for MPLAB ICE 2000.txt" in the MPLAB IDE installation directory or the latest *Product Selector Guide* (DS00148), which can be found on the Microchip web site at www.microchip.com.

A typical processor module contains a special bond-out version of a PICmicro MCU, with device buffers to control data flow and control logic. It provides the means of configuring the MPLAB ICE 2000 emulator for a specific PICmicro MCU family and handles low-voltage emulation when needed.

Note:	When removing the processor module, DO NOT pull on the flex cable. Use the tabs on the processor module or damage to the flex cable may occur.

4.1   Power

The operating voltage for most of the control logic and buffering on the processor module is +5V and is supplied by the emulator pod. Power to the emulator processor and some of its surrounding buffers is user-selectable, and can be powered by the emulator pod (at +5V only) or the target application system (from 2.0V to 5.5V). This is software selectable and is configurable through the MPLAB IDE software. At no time will the emulator system directly power the target application system. ALWAYS insert the processor module into the emulator pod before applying power to the pod.

When connecting to a target application system, there may be a voltage level on the target application even though power has not yet been applied power to the target application circuit. This is normal, and is due to current leakage through V_{CC} of the device adapter. The current leakage will typically be less than 20 mA. However, if the target application is using a voltage regulator, it should be noted that some regulators require the use of an external shunt diode between V_{IN} and V_{OUT} for reverse-bias protection. Refer to the manufacturer's data sheets for additional information.

4.1.1 EMULATOR PROCESSOR POWER SUPPLIED BY EMULATOR SYSTEM

If the emulator system is selected to power the emulator processor in the processor module, the emulator system can be operated without being connected to a target application. If the system is being connected to a target application, the power to the pod should be applied before applying power to the target application.

The target application system's Vcc will experience a small current load (10 mA typical) when the emulator system is connected via a device adapter. This is because the target system must always power the clock chip in the processor module.

4.1.2 EMULATOR PROCESSOR POWER SUPPLIED BY TARGET APPLICATION SYSTEM

When the MPLAB IDE software is brought up, the emulator system is first initialized with the emulator system powering the emulator processor. The "Processor Power Supplied by Target Board" option may then be selected using the **Power** tab of the Settings dialog (*Debugger>Settings*) to power the processor module from the target board.

When operating from external power, the processor module will typically represent a current load equivalent to the device being emulated (according to its data sheet) plus approximately 100 mA. Keep in mind that the target application will affect the overall current load of the processor module, dependent upon the load placed upon the processor I/O.

When the processor power is supplied by the target application system, an external clock (from the target board) may also be provided. MPLAB IDE will not allow use of an external clock without the use of external power.

4.1.3 OPERATING VOLTAGE OF 4.6 TO 5.5 VOLTS

If the target application system's operating voltage is between 4.55V (±120 mV) and 5.5V, the processor module will consider this a STANDARD VOLTAGE condition. In this mode the processor can run to its highest rated speed (as indicated in its data sheet).

The recommended power-up sequence is:

1. Apply power to the PC host.
2. Apply power to the emulator pod and processor module assembly.
3. Invoke MPLAB IDE.
4. Select *Debugger > Settings* and click the **Power** tab. Configure system for "Processor Power Supplied by Target Board".
5. At the error message, apply power to the target application circuit. Then acknowledge the error.
6. Issue a System Reset (from the debugger menu) before proceeding.

4.1.4 OPERATING VOLTAGE OF 2.0 TO 4.6 VOLTS

If the target application system's operating voltage is between 2.0V and 4.55V (±120 mV), the processor module will consider this a LOW VOLTAGE condition. In this mode the processor is limited to its rated speed at a given voltage level (as indicated in its data sheet).

To minimize the amount of reverse current that the target system is exposed to, the recommended power-up sequence is:

1. Apply power to the PC host.
2. Apply power to the emulator pod and processor module assembly.
3. Invoke MPLAB IDE.
4. Select *Debugger > Settings* and click the **Power** tab. Configure system for "Processor Power Supplied by Target Board".
5. At the error message, apply power to the target application circuit. Then acknowledge the error.
6. Issue a System Reset (from the debugger menu) before proceeding.
7. Select *Debugger > Settings* and click the **Power** tab. Verify that the dialog says "Low Voltage Enabled." Click **Cancel** to close the dialog.

4.2 Operating Frequency

The processor modules will support the maximum frequency (except where noted in **Section 3.0 Emulator-Related Issues**) of the device under emulation. The maximum frequency of a PICmicro MCU device is significantly lower when the operating voltage is less than 4.5V.

The processor modules will support a minimum frequency of 32 kHz. When operating at low frequencies, response to the screen may be slow.

4.3 Clock Options

MPLAB ICE 2000 allows internal and external clocking. When set to internal, the clock is supplied from the internal programmable clock, located in the Emulator Pod. When set to external, the oscillator on the target application system will be utilized.

4.3.1 CLOCK SOURCE FROM EMULATOR

Refer to the MPLAB ICE 2000 on-line help file in MPLAB IDE (*Help>Topics*) or the *MPLAB ICE 2000 User's Guide* (DS51488), "Using the On-Board Clock", for configuring MPLAB IDE to supply the clock source.

4.3.2 CLOCK SOURCE FROM THE TARGET APPLICATION

If the Target Application is selected to provide the clock source, the target board must also be selected to power the emulator processor (see the MPLAB ICE 2000 on-line help file in MPLAB IDE (*Help>Topics*) or the *MPLAB ICE 2000 User's Guide* (DS51488), "Using a Target Board Clock").

At low voltage, the maximum speed of the processor will be limited to the rated speed of the device under emulation.

An oscillator circuit on the device adapter generates a clock to the processor module and buffers the clock circuit on the target board. In this way, the MPLAB ICE 2000 emulator closely matches the oscillator options of the actual device. All oscillator modes are supported (as documented in the device's data sheet) except as noted in **Section 3.0 Emulator-Related Issues**. The OSC1 and OSC2 inputs of the device adapter have a 5 pF to 10 pF load. Be aware of this when using a crystal in HS, XT, LP or LF modes, or an RC network in RC mode.

The frequency of the emulated RC network may vary relative to the actual device due to emulator circuitry. If a specific frequency is important, adjust the RC values to achieve the desired frequency. Another alternative would be to allow the emulator to provide the clock as described in **Section 4.3.1 Clock Source from Emulator**.

When using the target board clock, the system's operating voltage is between 2.5V and 5.5V.

4.4 ESD Protection and Electrical Overstress

All CMOS chips are susceptible to electrostatic discharge (ESD). In the case of the processor modules, the pins of the CMOS emulator are directly connected to the target connector, making the chip vulnerable to ESD. ESD can also induce latch-up in CMOS chips, causing excessive current through the chip and possible damage. MPLAB ICE 2000 has been designed to minimize potential damage by implementing over-current protection and transient suppressors. However, care should be given to minimizing ESD conditions while using the system.

During development, contention on an I/O pin is possible (e.g., when an emulator pin is driving a '1' and the target board is driving a '0'). Prolonged contention may cause latch-up and damage to the emulator chip. One possible precaution is to use current limiting resistors (~100 Ω) during the development phase on bidirectional I/O pins. Using limiting resistors can also help avoid damage to modules, device adapters and pods that occurs when a voltage source is accidentally connected to an I/O pin on the target board.

4.5 Freeze Mode

The MPLAB ICE 2000 system allows the option of "freezing" peripheral operation or allowing them to continue operating when the processor is halted. This option is configured in the MPLAB IDE. The Freeze function is available on all processor modules except the PCM16XA0.

This function is useful to halt an on-board timer while at a break point. At a break point and while single stepping, interrupts are disabled.

5.0 DEVICE ADAPTER ISSUES

This section details processor-specific considerations that have been made on device adapters. Only adapters with special considerations are listed.

There will be a max of 10 mA of current draw from the target system even when the emulator processor module is being powered by the emulator system, and running internal clock. This is due to components on the device adapter being powered by the target board.

Processor Module and Device Adapter Specification

5.1 DVA12XP080

This device adapter is intended for use with PIC12C50X 8-pin DIP devices. It has four mechanical switches that allow target pins GP2 to GP5 to be routed to the emulator silicon on the PCM16XA0 processor module or the oscillator chip on the device adapter, as shown in Table 5-1.

In addition, a 24C00 EEPROM (U1) is connected to RA0 and RA1 of the emulator silicon to support the EEPROM capabilities of the PIC12CE51X family devices. For information on how to use EEPROM memory, see the MPLAB IDE on-line device-specific limitations for the PCM16XA0 (PIC12CE518/519) devices by selecting *Debugger>Settings*, clicking the **Limitations** tab, and then clicking the **Details** button.

TABLE 5-1: DVA12XP080 DEVICE ADAPTER SWITCH ASSIGNMENT

Desired Function	Switch Positions
RB2	Set S4 to **RB2**
RB3	Set S3 to **RB3**
RB4	Set S2 to **RB4**
RB5	Set S1 to **RB5**
$\overline{\text{MCLR}}$	Set S3 to $\overline{\text{MCLR}}$
External Oscillator Input	Set S1 to **OSC1** and set S2 to **OSC2**
TIMER0 Clock Input	Set S4 to **T0CKI**

5.2 DVA12XP081

This device adapter is intended for use with PIC12C67X 8-pin DIP devices. It has two mechanical switches that allow target pins GP4 and GP5 to be routed to the emulator silicon on the PCM12XA0 processor module or the oscillator device on the device adapter, as shown in Table 5-2.

TABLE 5-2: DVA12XP081 DEVICE ADAPTER SWITCH ASSIGNMENT

Desired Function	Switch Positions
GP4	Set S2 to **GP4**
GP5	Set S1 to **GP5**
External Oscillator Input	Set S1 to **OSC1** and set S2 to **OSC2**

5.3   DVA14XP280

This device adapter is intended for use with the PIC14000 28-pin DIP device. It has two mechanical switches that allow target pins OSC1 and OSC2 to be routed to the emulator silicon on the PCM14XA0 processor module or the oscillator device on the device adapter, as shown in Table 5-3.

TABLE 5-3:   DVA14XP280 DEVICE ADAPTER SWITCH ASSIGNMENT

Desired Function	Switch Position
IN Mode	Set S1 to **OSC2INT** Set S2 to **OSC1INT**
HS Mode	Set S1 to **OSC2EXT** Set S2 to **OSC1EXT**

5.4   DVA16XP140

This device adapter is intended for use with the PIC16C505 14-pin DIP device. It has four mechanical switches. Two of the switches allow target pins RB4 and RB5 to be routed to the emulator silicon on the PCM16XA0 processor module or the oscillator device on the device adapter. The other two switches control the routing of RB3 and RC5 signals. RB3 can be a general-purpose input or MCLR. RC5 can be a general purpose I/O or can drive the TOCKI input, as shown in Table 5-4.

TABLE 5-4:   DVA16XP140 DEVICE ADAPTER SWITCH ASSIGNMENT

Desired Function	Switch Positions
RC5	Set S4 to **RC5**
RB3	Set S3 to **RB3**
RB4	Set S2 to **RB4**
RB5	Set S1 to **RB5**
MCLR	Set S3 to **MCLR**
External Oscillator Input	Set S1 to **OSC1** and set S2 to **OSC2**
TIMER0 Clock Input	Set S4 to **T0CKI**

5.5   DVA16XP182

This device adapter is intended for use with PIC16C712/716 18-pin DIP devices. It has a second oscillator device that allows TIMER1 oscillator input ranging from 32-40 kHz. It has four mechanical switches. Target pins RB1 and RB2 can be routed to the emulator silicon on the PCM16XE1 processor module or the TIMER1 oscillator device on the device adapter. Target pin RB1 is routed to T1CKI. Target pin RB3 can be a general purpose input or CCP1, as shown in Table 5-5.

TABLE 5-5:   DVA16XP182 DEVICE ADAPTER SWITCH ASSIGNMENT

Desired Function	Switch Positions
RB1	Set S2-1 to position **B**
RB2	Set S2-2 to position **B**
RB3	Set S2-3 to position **B**
CCP1	Set S2-3 to position **A**
TIMER1 Clock Input	Set S2-1 to position **A** and set S1 to position **B**
TIMER1 Oscillator Input	Set S2-1 to position **A** and set S2-2 to position **A** and set S1 to position **A**

MPLAB® ICE 2000

5.6   DVA16XP187

This device adapter is intended for use with PIC16F716 18-pin DIP devices. It has a second oscillator device that allows TIMER1 oscillator input ranging from 32-40 kHz. It has four mechanical switches. Target pins RB1 and RB2 can be routed to the emulator silicon on the PCM16YJ0 processor module or the TIMER1 oscillator device on the device adapter. Target pin RB1 is routed to T1CKI. Target pin RB3 can be a general purpose input or CCP1, as shown in Table 5-5.

TABLE 5-6:   DVA16XP187 DEVICE ADAPTER SWITCH ASSIGNMENT

Desired Function	Switch Positions
RB1	Set S2-1 to position **B**
RB2	Set S2-2 to position **B**
RB3	Set S2-3 to position **B**
CCP1	Set S2-3 to position **B**
TIMER1 Clock Input	Set S2-1 to position **B** and set S1 to position **B**
TIMER1 Oscillator Input	Set S2-1 to position **A** and set S2-2 to position **A** and set S1 to position **A**

5.7   DVA16XP282, DVA16XP401, DVA16XL441 and DVA16PQ441

These device adapters are intended for use with PICmicro MCU devices supported by the PCM16XB0/B1, PCM16XE0/E1, PCM16XK0 and the PCM16XL0 processor modules. The device adapters have a second oscillator device that allows TIMER1 oscillator input ranging from 32 to 40 kHz.

For PCM16XB0/B1, PCM16XE0/E1, PCM16XK0 and PCM16XL0, configure jumper J1 per Table 5-7.

For all other processor modules supported by these device adapters, leave the jumper on pins 1-2 (**OFF**); the Timer1 oscillator enable/disable function is software configurable.

TABLE 5-7:   DVA16XP282, DVA16XP401, DVA16XL441 AND DVA16PQ441 JUMPER SETTINGS

Desired Function	Switch Positions	Results
TIMER1 Oscillator Input enabled	Short J1 pins 2-3 (**ON**)	RC0/T1OSO/T1CKI pin = **T1OSO** RC1/T1OSI/CCP2 pin = **T1OSI**
TIMER1 Oscillator Input disabled	Short J1 pins 1-2 (**OFF**)	RC0/T1OSO/T1CKI pin = **RC0** or **T1CKI** RC1/T1OSI/CCP2 pin = **RC1** or **CCP2**

5.8   DVA17XXXX0

These device adapters are intended for use with PICmicro MCU devices supported by the PCM17XA0 processor module. In all processors in EC mode, OSC/4 is not supported. OSC/4 in EC mode is supported in DVA17XXXX1 device adapters.

5.9   Emulating a .600 28-Pin Part

When emulating a .600 wide, 28-pin device, an adapter will be needed to convert the standard .300 wide socket on the device adapters to the .600 wide socket on the target board.

There are many adapters available for this purpose, such as Digi-Key part number A502-ND.

5.10   T1OSC Jumper

Some device adapters are equipped with a 3-pin jumper to force the device adapter to enable/disable the Timer1 oscillator circuitry.

When in the "ON" position, the device adapter's Timer1 oscillator circuitry is always enabled regardless of the T1OSCEN bit in T1CON.

When in the "OFF" position, the device adapter's Timer1 oscillator circuit is enabled/disabled by software in application code by the T1OSCEN bit in T1CON.

Note:	PCM16XB0/B1, PCM16XE0/E1, PCM16XK0 and PCM16XL0 do not support software enable/disable of the Timer1 circuitry and must use the jumper to either enable of disable the function (see Table 5-7 for DVA16XP282, DVA16XP401, DVA16XL441 and DVA16PQ441).

NOTES:

Note the following details of the code protection feature on Microchip devices:

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